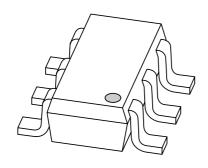
DISCRETE SEMICONDUCTORS

DATA SHEET



PMEM4010ND NPN transistor/Schottky diode module

Product data sheet Supersedes data of 2002 Oct 28 2003 Jul 04



NPN transistor/Schottky diode module

PMEM4010ND

FEATURES

- 600 mW total power dissipation
- · High current capability
- Reduces required PCB area
- · Reduced pick and place costs
- Small plastic SMD package.

Transistor:

· Low collector-emitter saturation voltage.

Diode:

- · Ultra high-speed switching
- · Very low forward voltage
- · Guard ring protected.

APPLICATIONS

- DC/DC convertors
- · Inductive load drivers
- · General purpose load drivers
- Reverse polarity protection circuits.

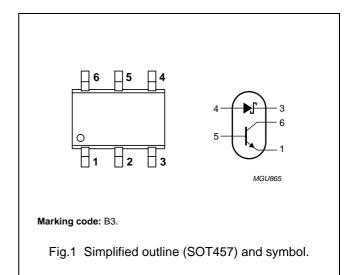
DESCRIPTION

Combination of an NPN transistor with low V_{CEsat} and high current capability and a planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package.

PNP complement: PMEM4010PD.

PINNING

PIN	DESCRIPTION		
1	emitter		
2	not connected		
3	cathode		
4	anode		
5	base		
6	collector		



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
NPN trans	NPN transistor						
V _{CBO}	collector-base voltage	open emitter	_	40	V		
V _{CEO}	collector-emitter voltage	open base	_	40	V		
V _{EBO}	emitter-base voltage	open collector	-	5	V		
I _C	collector current (DC)		_	1	А		
I _{CM}	peak collector current		-	2	Α		
I _{BM}	peak base current		-	1	А		
Tj	junction temperature		-	150	°C		
Schottky I	Schottky barrier diode						
V_R	continuous reverse voltage		_	20	V		
I _F	continuous forward current		_	1	А		
I _{FSM}	non repetitive peak forward current	t = 8.3 ms half sinewave; JEDEC method	-	5	A		
Tj	junction temperature		_	125	°C		
Combined device							
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	600	mW		
T _{stg}	storage temperature		-65	+150	°C		
T _{amb}	operating ambient temperature	note 2	-65	+125	°C		

Notes

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 2. For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses P_R are significant part of the total power losses. Nomograms for determination of the reverse power losses P_R and I_F (AV) rating will be available on request.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air; note 1	208	K/W

Note

1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².

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ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		TYP.	MAX.	UNIT	
NPN transistor							
I _{CBO}	collector-base cut-off current	V _{CB} = 40 V; I _E = 0	_	_	100	nA	
		V _{CB} = 40 V; I _E = 0; T _{amb} = 150 °C	_	_	50	μΑ	
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0	_	_	100	nA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA	
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1 mA	300	_	_		
		V _{CE} = 5 V; I _C = 500 mA	300	_	900		
		V _{CE} = 5 V; I _C = 1 A	200	_	_		
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 1 mA	_	_	80	mV	
		I _C = 500 mA; I _B = 50 mA	_	_	110	mV	
		I _C = 1 A; I _B = 100 mA	_	_	210	mV	
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	_	_	1.2	V	
R _{CEsat}	equivalent on-resistance	$I_C = 500 \text{ mA}$; $I_B = 50 \text{ mA}$; note 1	_	260	<220	mΩ	
V_{BEon}	base-emitter turn-on voltage	V _{CE} = 5 V; I _C = 1 A	_	_	1.1	V	
f _T	transition frequency	I _C = 50 mA; V _{CE} = 10 V; f = 100 MHz	150	_	_	MHz	
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ ; } f = 1 \text{ MHz}$	_	_	10	pF	
Schottky barrier diode							
V _F	continuous forward voltage	I _F = 10 mA; note 1	_	240	270	mV	
		I _F = 100 mA; note 1	_	300	350	mV	
		I _F = 1000 mA; see Fig.7; note 1	_	480	550	mV	
I _R	reverse current	V _R = 5 V; note 1	_	5	10	μА	
		V _R = 8 V; note 1	_	7	20	μΑ	
		V _R = 15 V; see Fig.8; note 1	-	10	50	μΑ	
C _d	diode capacitance	V _R = 5 V; f = 1 MHz; see Fig.9	_	19	25	pF	

Note

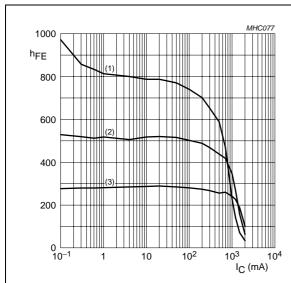
1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

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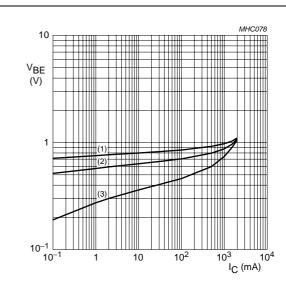
GRAPHICAL DATA



NPN transistor; $V_{CE} = 5 \text{ V}.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

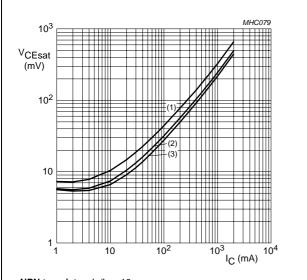
Fig.2 DC current gain as a function of collector current; typical values.



NPN transistor; $V_{CE} = 5 \text{ V}.$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

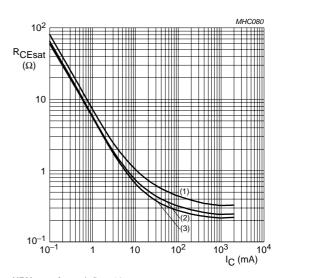
Fig.3 Base-emitter voltage as a function of collector current; typical values.



NPN transistor; $I_C/I_B = 10$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



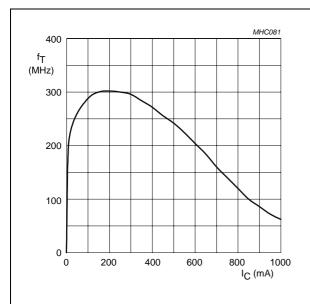
NPN transistor; $I_C/I_B = 10$.

- (1) T_{amb} = 150 °C.
- (2) T_{amb} = 25 °C.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.5 Equivalent on-resistance as a function of collector current; typical values.

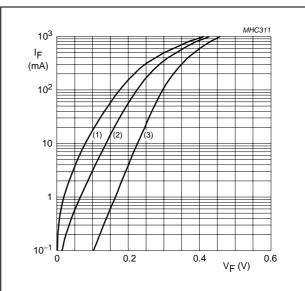
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NPN transistor; $V_{CE} = 10 \text{ V}.$

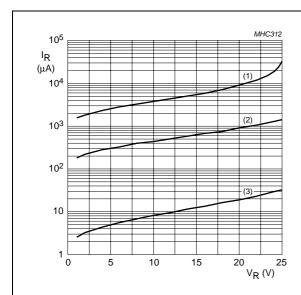
Fig.6 Transition frequency as a function of collector current.



Schottky barrier diode.

- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.

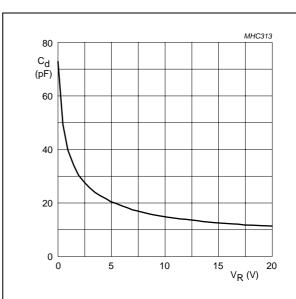
Fig.7 Forward current as a function of forward voltage; typical values.



Schottky barrier diode.

- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.

Fig.8 Reverse current as a function of reverse voltage; typical values.



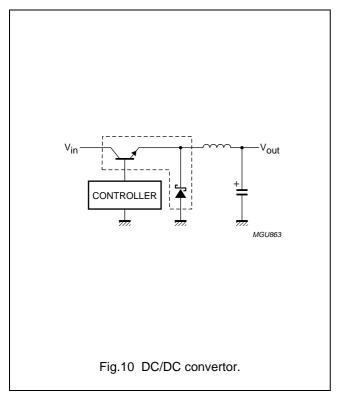
Schottky barrier diode; f = 1 MHz; T_{amb} = 25 °C.

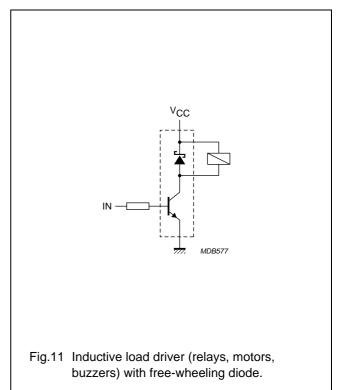
Fig.9 Diode capacitance as a function of reverse voltage; typical values.

NPN transistor/Schottky diode module

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APPLICATION INFORMATION





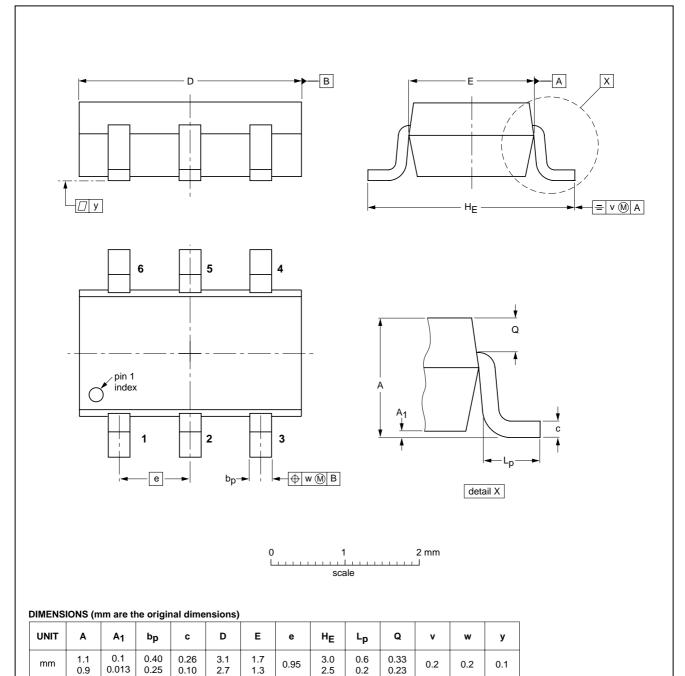
NPN transistor/Schottky diode module

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PACKAGE OUTLINE

Plastic surface mounted package; 6 leads

SOT457



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE DAT	
SOT457			SC-74			97-02-28 01-05-04

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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2003 Jul 04

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